



ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		585 (YELLOW)		nm	
		565 (GREEN)		nm	
FORWARD VOLTAGE (Y/G)		2.1/2.2	2.5/2.6	V _f	
REVERSE VOLTAGE	5.0			V _r	I _r =100 μ A
AXIAL INTENSITY		20		mcd	I _f =20mA
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	YELLOW/GREEN				
EPOXY LENS FINISH:	MILKY WHITE DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	COLORS	MAX	UNITS
PEAK FORWARD CURRENT*		150	mA
STEADY CURRENT	(Y/G)	30/25	mA
POWER DISSIPATION		105	mW
DERATE FROM 25°C		-1.2	mW/°C
OPERATING, STORAGE TEMP.		-40 TO +85	°C
SOLDERING TEMP.		+260	°C
2.0mm FROM BODY			3 SEC. MAX

* $t < 10\mu\text{s}$

NOTES:

1. SSL-LX5093YGW LED, CUT LEADS TO 4mm.
2. SSH-RTF5020 HOLDER.
3. YELLOW ANODE LEAD: LXP-WST24RDTOC CUT 235 LONG, STRIP 3mm & 9.5mm.
4. GREEN ANODE LEAD: LXP-WST24BLTOC CUT 235 LONG, STRIP 3mm & 9.5mm.
5. LXP-HEATSHRINK-2, (2 PCS.) 1/16" x 1/2" LONG.

PANEL CUTOUT: 8.05mm
PANEL THICKNESS: 0.6~2.8mm

CAUTION: PRESSURE SENSITIVE ASSEMBLY
AVOID APPLYING PRESSURE TO LED
DURING PANEL ASSEMBLY.



*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN.= +DECIMAL PRECISION -0.00, MAX.= +0.00 -DECIMAL PRECISION

REV.	PART NUMBER SSI-LXR5020YGW-225	CONFIDENTIAL INFORMATION THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF LUMEX INC. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY LUMEX INC., THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.	290 E. HELEN ROAD PALATINE, IL 60067-6976 PHONE: +1.847.359.2790 US WEB: www.lumex.com TW WEB: www.lumex.com.tw
T-5mm (T-1 3/4) ROUND PANEL INDICATOR LED, 585nm YELLOW/565nm GREEN BICOLOR LED, MILKY WHITE LENS, WITH 9" WIRE LEADS.	RELIABILITY NOTE OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.	DRAWN BY: JN	CHECKED BY: APPROVED BY: DATE: 10.25.07 PAGE: 1 OF 1 SCALE: N/A